The 4th International Symposium on Biomedical Engineering

Sponsored by Ministry of Education, Culture, Sports, Science and Technology (MEXT)

November 14-15,

Venue: Act City Hamamatsu Congress Center,

Hamamatsu, Japan

Access: Five minutes' walk from JR Hamamatsu station

アクトシティ浜松コングレスセンター

(JR浜松駅徒歩5分)

"The Research Center of Biomedical Engineering (RCBE) was established in April, 2016, by support of the Ministry of Education, Culture, Sports, Science and Technology (MEXT). The international symposium on biomedical engineering is organized as a part of the activities in the RCBE. Through the collaborative research in the interdisciplinary field between medicine and engineering, we discuss the global issues on future medicine and healthcare, and develop innovative technologies to realize a healthy aging society."

Organizers:

- · Institute of Biomaterials and Bioengineering, **Tokyo Medical and Dental University**
- · Laboratory for Future Interdisciplinary Research of Science and Technology, Tokyo Institute of Technology
- Research Institute for Nanodevice and Bio Systems, **Hiroshima University**
- Research Institute of Electronics, Shizuoka University

主催:東京医科歯科大学 生体材料工学研究所 東京工業大学 未来産業技術研究所

広島大学 ナノデバイス・バイオ融合科学研究所

静岡大学 電子工学研究所

共催:静岡大学

Invited Speakers

Christian Crouzet and Bernard Choi,

University of California, Irvine, USA

Muhammad A. Elahi,

National University of Ireland, Ireland

ldzidhar Idris.

Technical University of Malaysia Malacca, Malaysia

Deok-Ho Kim.

University of Washington, USA

Chenakuo Lee.

National University of Singapore, Singapore

Registration deadline for poster pre

Submission deadline for abstract

Registration deadline

for participation

Aug. 31, 2019

Sep. 13, 2019

Oct. 31, 2019

Ferdinand Felder, Production 3000

Tsukasa Funane, HITACHI, Ltd.

Koji Mizukoshi, Pola Chemical Industries, Inc.

Academic-Industrial Collaboration Session

Hiroyuki Tada, CHARMANT INC.

ポスター発表登壇申込締切 2019年 8月31日(土)

ポスター発表予稿提出締切 2019年 9月13日(金)

参加申込締切 2019年10月31日(木)

Registration fee is free. Pre-registration is preferable.

Networking fee:

JPY6,000 for regular participants, JPY2,000 for students. The networking fee should be paid on site.

Registration for the networking is required in advance.

Contact:

Research Institute of Electronics (RIE),

Shizuoka University

3-5-1 Johoku, Naka-ku, Hamamatsu

432-8011, Japan

Phone: 053-478-1301 FAX:053-478-1651 E-mail: isbe2019@adb.shizuoka.ac.jp

シンポジウム参加費: 無料

懇談会参加費: 6,000円(学生 2,000円)

お申し込み・お問い合わせ先

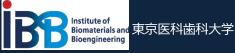
静岡大学電子工学研究所

〒432-8011 浜松市中区城北3-5-1

TEL: 053-478-1301 FAX: 053-478-1651

E-mail: isbe2019@adb.shizuoka.ac.jp

Web Site: http://www.rie.shizuoka.ac.jp/~conference/isbe2019/









The 4th International Symposium on Biomedical Engineering

Program

November 14 (11月14日)

12:40~13:00	Opening Remarks
13:00~14:35	Session A
14:35~15:00	Photo Session
15:00~16:30	Poster Session 1 & Coffee Break
16:30~18:05	Session B
18:30~20:00	Networking

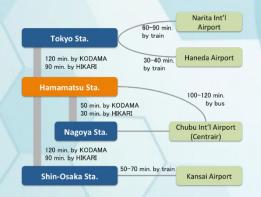
November 15 (11月15日)

9:00~ 9:05	Announcement
9:05~10:50	Session C
10:50~12:20	Poster Session 2 & Coffee Break
12:20~13:40	Lunch Break
13:40~15:20	Academic-Industrial Collaboration Session
15:20~15:40	Coffee Break
15:40~17:15	Session D
17:15~17:30	Closing Remarks (Award Ceremony)

Organizing Committee:

Yuji Miyahara, Tokyo Medical and Dental University
Akihiro Miyauchi, Tokyo Medical and Dental University
Takeshi Hatsuzawa, Tokyo Institute of Technology
Hideki Hosoda, Tokyo Institute of Technology
Seiichiro Higashi, Hiroshima University
Hidenori Mimura, Shizuoka University
Koji Mori, Shizuoka University

Access to Hamamatsu



Technical Program Committee:

Yuji Miyahara, Tokyo Medical and Dental University Kohji Mitsubayashi, Tokyo Medical and Dental University Kenji Kawashima, Tokyo Medical and Dental University Ryoichi Nakamura, Tokyo Medical and Dental University Takeshi Hatsuzawa, Tokyo Institute of Technology Hideki Hosoda, Tokyo Institute of Technology Seiichiro Higashi, Hiroshima University Hidenori Mimura, Shizuoka University Koji Mori, Shizuoka University Tetsuo Sasaki, Shizuoka University Yoichiro Nakanishi, Shizuoka University Shin Usuki, Shizuoka University Atsushi Ono, Shizuoka University Masatsugu Niwayama, Shizuoka University Tomoaki Masuzawa, Shizuoka University Tadanobu Koyama, Shizuoka University







